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Texas Instruments
SN65MLVD200D

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Datasheet of SN65MLVD200D - IC DIFF LINE DRVR/RCVR HS 8-SOIC

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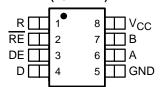
## SN65MLVD200, SN65MLVD202 SN65MLVD204, SN65MLVD205 MULTIPOINT-LVDS LINE DRIVERS AND RECEIVERS

SLLS463E - SEPTEMBER 2001 - REVISED JUNE 2003

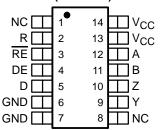
- Low-Voltage Differential 30-Ω Line Drivers and Receivers for Signaling Rates<sup>†</sup> up to 100 Mbps
- Power Dissipation at 100 Mbps
  - Driver: 50 mW Typical
  - Receiver: 30 mW Typical
- Meets or Exceeds Current Revision of M-LVDS Standard TIA/EIA-899 for Multipoint Data Interchange
- Controlled Driver Output Voltage Transition Times for Improved Signal Quality
- -1-V to 3.4-V Common-Mode Voltage Range Allows Data Transfer With up to 2 V of Ground Noise
- Type-1 Receivers Incorporate 25 mV of Hysteresis

- Type-2 Receivers Provide an Offset (100 mV) Threshold to Detect Open-Circuit and Idle-Bus Conditions
- Operates From a Single 3.3-V Supply
- Propagation Delay Times Typically 2.3 ns for Drivers and 5 ns for Receivers
- Power-Up/Down Glitch-Free Driver
- Driver Handles Operation Into a Continuous Short Circuit Without Damage
- Bus Pins High Impedance When Disabled or V<sub>CC</sub> ≤ 1.5 V
- 200-Mbps Devices Available (SN65MLVD201, 203, 206, and 207)

SN65MLVD200D (Marked as MF200) SN65MLVD204D (Marked as MF204) (TOP VIEW)



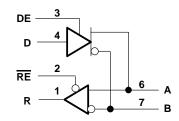
#### SN65MLVD202D (Marked as MLVD202) SN65MLVD205D (Marked as MLVD205) (TOP VIEW)



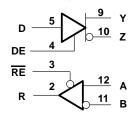
NC - No internal connection

#### logic diagram (positive logic)

SN65MLVD200, SN65MLVD204



#### SN65MLVD202, SN65MLVD205





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

The signaling rate of a line is the number of voltage transitions that are made per second expressed in bps (bits per second) units.





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SN65MLVD200, SN65MLVD202 **SN65MLVD204, SN65MLVD205** MULTIPOINT-LVDS LINE DRIVERS AND RECEIVERS SLLS463E - SEPTEMBER 2001 - REVISED JUNE 2003

#### description

This series of SN65MLVD20x devices are low-voltage differential line drivers and receivers complying with the proposed multipoint low-voltage differential signaling (M-LVDS) standard (TIA/EIA-899). These circuits are similar to their TIA/EIA-644 standard compliant LVDS counterparts, with added features to address multipoint applications. Driver output current has been increased to support doubly-terminated, 50-Ω load multipoint applications. Driver output slew rates are optimized for signaling rates up to 100 Mbps.

Types 1 and 2 receivers are available. Both types of receivers operate over a common-mode voltage range of -1 V to 3.4 V to provide increased noise immunity in harsh electrical environments. Type-1 receivers have their differential input voltage thresholds near zero volts (±50 mV), and include 25 mV of hysteresis to prevent output oscillations in the presence of noise. Type-2 receivers include an offset threshold to detect open-circuit, idle-bus, and other fault conditions, and provide a known output state under these conditions.

The intended application of these devices is in half-duplex or multipoint baseband data transmission over controlled impedance media of approximately  $100-\Omega$  characteristic impedance. The transmission media may be printed circuit board traces, backplanes, or cables. (Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other application-specific characteristics).

These devices are characterized for operation from -40°C to 85°C.

#### **AVAILABLE OPTIONS**

NOMINAL SIGNALING RATE, Mbps	FOOTPRINT	RECEIVER TYPE	PART NUMBER†
100	SN75176	Type 1	SN65MLVD200D
100	SN75ALS180	Type 1	SN65MLVD202D
100	SN75176	Type 2	SN65MLVD204D
100	SN75ALS180	Type 2	SN65MLVD205D

<sup>&</sup>lt;sup>†</sup> The D package is available taped and reeled. Add the R suffix to the device type (e.g., SN65MLVD200DR)

#### **Function Tables**

**TYPE-1 RECEIVER (200, 202)** 

INPUTS		OUTPUT
<b>V<sub>ID</sub> = V<sub>A</sub> - V</b> <sub>B</sub>	RE	R
V <sub>ID</sub> ≥ 50 mV	L	Н
-50 mV < V <sub>ID</sub> < 50 mV	L	?
$V_{ID} \le -50 \text{ mV}$	L	L
X	Н	Z
X	Open	Z
Open Circuit	L	?

**TYPE-2 RECEIVER (204, 205)** 

INPUTS		OUTPUT
$V_{ID} = V_A - V_B$	RE	R
V <sub>ID</sub> ≥ 150 mV	L	Н
50 mV < V <sub>ID</sub> < 150 mV	L	?
$V_{ID} \leq 50 \text{ mV}$	L	L
X	Н	Z
X	Open	Z
Open Circuit	L	L

#### DRIVER

INPUT	ENABLE	OUTPUTS			
D	DE	A OR Y	B OR Z		
L	Н	L	Н		
Н	Н	Н	L		
OPEN	Н	L	Н		
Х	OPEN	Z	Z		
X	L	Z	Z		

H = high level, L = low level, Z = high impedance, X = Don't care, ? = indeterminate



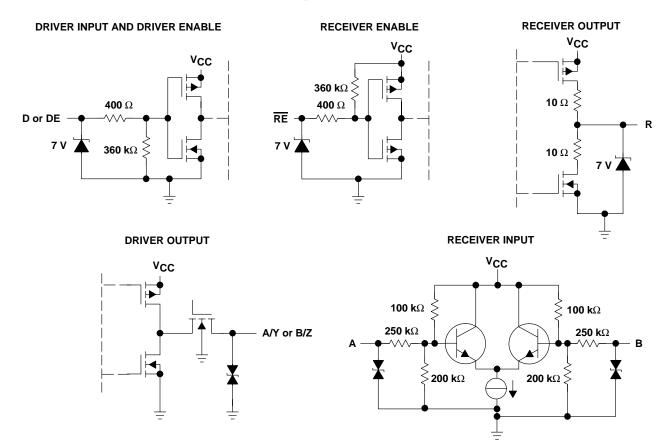


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#### equivalent input and output schematic diagrams







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#### absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub> (see Note 1)	–0.5 V to 4 V
Input voltage range: D, DE, RE	–0.5 V to 4 V
A, B (200, 204)	–1.8 V to 4 V
A, B (202, 205)	
Output voltage range: R	–0.3 V to 4 V
Y, Z, A, or B	–1.8 V to 4 V
Electrostatic discharge: Human body model (see Note 2)	A, B, Y, or Z ±3 kV
	All pins ±2 kV
Charged-device model (see Note 3)	All pins±500 V
Continuous power dissipation	(see Dissipation Rating table)
Storage temperature range	–65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 secon	nds 260°C

<sup>†</sup> Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.
  - 2. Tested in accordance with JEDEC Standard 22, Test Method A114-A.
  - 3. Tested in accordance with JEDEC Standard 22, Test Method C101.

#### **DISSIPATION RATING**

PACKAGE	$T_{\mbox{\scriptsize A}} \le 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	OPERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 85°C POWER RATING
D(8)	725 mW	5.8 mW/°C	377 mW
D(14)	950 mW	7.6 mW/°C	494 mW

#### recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	3	3.3	3.6	V
High-level input voltage, V <sub>IH</sub>	2		VCC	V
Low-level input voltage, V <sub>IL</sub>	0		8.0	V
Magnitude of differential input voltage,  V <sub>ID</sub>	0.05		VCC	V
Voltage at any bus terminal, $V_A$ , $V_Y$ , $V_{Z, or} V_B$	-1.4		3.8	V
Common-mode input voltage $V_{CM}$ , $(V_A + V_B)/2$	-1		3.4	V
Receiver load capacitance, C <sub>L</sub>	5		15	pF
Operating free-air temperature, T <sub>A</sub>	-40		85	°C





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# device electrical characteristics over recommended operating conditions (unless otherwise noted)

		PARAMETER	TEST CONDITIONS	MIN†	TYP <sup>‡</sup>	MAX	UNIT
		Receiver disabled and driver enabled	RE and DE at $V_{CC}$ , $R_L = 50 \Omega$ , All others open		13	22	
		Driver and receiver disabled	RE at V <sub>CC</sub> , DE at 0 V, R <sub>L</sub> = No load, All others open		1	7	
ICC	Supply current	Receiver enabled and driver enabled	$\overline{\text{RE}}$ at 0 V, DE at V <sub>CC</sub> , R <sub>L</sub> = 50 $\Omega$ , All others open, No receiver load		16	26	mA
		Receiver enabled and driver disabled	RE at 0 V, DE at 0 V, All others open, No receiver load		4	11	

<sup>†</sup> The algebraic convention, in which the least positive (most negative) limit is designated as minimum, is used in this data sheet.

#### driver electrical characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN†	TYP‡ MAX	UNIT
V <sub>AB</sub>   or  V <sub>YZ</sub>	Differential output voltage magnitude	See Figure 2	480	650	mV
$\Delta  V_{AB} $ or $\Delta  V_{YZ} $	Change in differential output voltage magnitude between logic states	See Figure 2	-50	50	mV
Vos(ss)	Steady-state common-mode output voltage		0.8	1.2	V
ΔVOS(SS)	Change in steady-state common-mode output voltage between logic states	See Figure 3	-50	50	mV
VOS(PP)	Peak-to-peak common-mode output voltage			150	mV
V <sub>A</sub> (OC) or V <sub>Y</sub> (OC)	Maximum steady-state open-circuit output voltage	One Figure 7	0	2.4	V
V <sub>B(OC)</sub> or V <sub>Z(OC)</sub>	Maximum steady-state open-circuit output voltage	See Figure 7	0	2.4	V
V <sub>P(H)</sub>	Voltage overshoot, low-to-high level output	Con Figure 5		1.2V <sub>SS</sub>	V
V <sub>P(L)</sub>	Voltage overshoot, high-to-low level output	See Figure 5	-0.2V <sub>SS</sub>		V
lн	High-level input current	V <sub>IH</sub> = 2 V	0	10	μΑ
IIL	Low-level input current	V <sub>IL</sub> = 0.8 V	0	10	μΑ
los	Differential short-circuit output current	See Figure 4		24	mA
loz	High-impedance state output current (driver only)	$-1.4 \text{ V} \le (\text{V}\gamma \text{ or V}Z) \le 3.8 \text{ V},$ Other output at 1.2 V	-15	10	μΑ
IO(OFF)	Power-off output current (driver only)	$ \begin{array}{l} -1.4 \text{ V} \leq (\text{V}\gamma \text{ or V}Z) \leq 3.8 \text{ V}, \\ \text{V}_{CC} \leq 1.5 \text{ V}, \\ \text{Other output at } 1.2 \text{ V} \end{array} $	-10	10	μΑ

The algebraic convention, in which the least positive (most negative) limit is designated as minimum, is used in this data sheet.



<sup>&</sup>lt;sup>‡</sup> All typical values are at 25°C and with a 3.3-V supply voltage.

<sup>&</sup>lt;sup>‡</sup> All typical values are at 25°C and with a 3.3-V supply voltage.



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# receiver electrical characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
,	Design and the Property of the Control of the Contr	Type 1				50	
V <sub>IT+</sub>	Positive-going differential input voltage threshold	Type 2				150	mV
.,	No action as in a differential in a total to a through all	Type 1	See Figure 8,	-50			\/
V <sub>IT</sub> _	Negative-going differential input voltage threshold	Type 2	Table 1 and Table 2	50			mV
V	Differential input valtege by steresis V	Type 1			25		ms\/
V <sub>ID(HYS)</sub>	Differential input voltage hysteresis, V <sub>IT+</sub> – V <sub>IT-</sub>	Type 2			0		mV
Vон	High-level output voltage		I <sub>OH</sub> = –8 mA	2.4			V
VOL	Low-level output voltage		I <sub>OL</sub> = 8 mA			0.4	V
lн	High-level input current		V <sub>IH</sub> = 2 V	-10		0	μΑ
IլL	Low-level input current		V <sub>IL</sub> = 0.8 V	-10		0	μΑ
loz	High-impedance output current		V <sub>O</sub> = 0 V or 3.6 V	-10		15	μΑ

 $<sup>\</sup>ensuremath{^{\dagger}}$  All typical values are at 25°C and with a 3.3-V supply voltage.

# bus input and output electrical characteritics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup> MA	X UNIT
		$V_A = 3.8 \text{ V}, \qquad V_B = 1.2 \text{ V}$	0	3	2
IA	Receiver input or transceiver input/output current	$V_A = 0 \text{ V or } 2.4 \text{ V},  V_B = 1.2 \text{ V}$	-20	2	0 μΑ
	our or a	$V_A = -1.4 \text{ V}, \qquad V_B = 1.2 \text{ V}$	-32		0
		$V_B = 3.8 \text{ V}, \qquad V_A = 1.2 \text{ V}$	0	3	2
lΒ	Receiver input or transceiver input/output current	$V_B = 0 \text{ V or } 2.4 \text{ V},  V_A = 1.2 \text{ V}$	-20	2	0 μΑ
	ouron	$V_B = -1.4 \text{ V}, \qquad V_A = 1.2 \text{ V}$	-32		0
I <sub>AB</sub>	Receiver input or transceiver input/output differential current ( $I_A - I_B$ )	$V_A = V_B$ , $-1.4 \le V_A \le 3.8 \text{ V}$	-4		4 μΑ
		$V_A = 3.8 \text{ V}, \qquad V_B = 1.2 \text{ V},  V_{CC} \le 1.5 \text{ V}$	0	3	2
I <sub>A</sub> (OFF)	Receiver input or transceiver input/output power-off current	$V_A = 0 \text{ V or } 2.4 \text{ V},  V_B = 1.2 \text{ V},  V_{CC} \le 1.5 \text{ V}$	-20	2	0 μΑ
	power-on current	$V_A = -1.4 \text{ V}, \qquad V_B = 1.2 \text{ V},  V_{CC} \le 1.5 \text{ V}$	-32		0
		$V_B = 3.8 \text{ V}, \qquad V_A = 1.2 \text{ V},  V_{CC} \le 1.5 \text{ V}$	0	3	2
I <sub>B</sub> (OFF)	Receiver input or transceiver input/output power-off current	$V_B = 0 \text{ V or } 2.4 \text{ V},  V_A = 1.2 \text{ V},  V_{CC} \le 1.5 \text{ V}$	-20	2	0 μΑ
. ,	power on ourient	$V_B = -1.4 \text{ V}, \qquad V_A = 1.2 \text{ V},  V_{CC} \le 1.5 \text{ V}$	-32		0
I <sub>AB</sub> (OFF)	Receiver input or transceiver input/output power-off differential current (I <sub>A</sub> – I <sub>B</sub> )	$V_A = V_B$ , $-1.4 \le V_A \le 3.8 \text{ V}$ , $V_{CC} \le 1.5 \text{ V}$	-4		4 μΑ
C <sub>A</sub>	Receiver input, driver high-impedance output, or transceiver input/output	$V_A = 0.4 \sin(2E8\pi t) + 0.5$ , $V_B = 1.2 V$		3	pF
CB	capacitance	$V_B = 0.4 \sin(2E8\pi t) + 0.5$ , $V_A = 1.2 V$		3	pF

<sup>&</sup>lt;sup>†</sup> All typical values are at 25°C and with a 3.3-V supply voltage.





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# driver switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output		1.6	2.3	4.1	ns
tPHL	Propagation delay time, high-to-low-level output		1.6	2.3	4.1	ns
t <sub>r</sub>	Differential output signal rise time	055	1.5	2	3	ns
tf	Differential output signal fall time	See Figure 5	1.5	2	3	ns
t <sub>sk(p)</sub>	Pulse skew ( tpHL tpLH )	1		30		ps
t <sub>sk(pp)</sub>	Part-to-part skew (see Note 4)				900	ps
<sup>t</sup> PZH	Propagation delay time, high-impedance-to-high-level output		1.5	3.7	6.5	ns
t <sub>PZL</sub>	Propagation delay time, high-impedance-to-low-level output	] 	1.5	3.7	6.5	ns
<sup>t</sup> PHZ	Propagation delay time, high-level-to-high-impedance output	See Figure 6	1.3	3.5	6.8	ns
t <sub>PLZ</sub>	Propagation delay time, low-level-to-high-impedance output	1	1.8	3.5	6.1	ns
<sup>t</sup> jit(per)	Period jitter, rms (1 standard deviation) (see Notes 5 and 6)	50-MHz clock input (see Figure 8)		23		ps
<sup>t</sup> jit(cc)	Cycle-to-cycle jitter, peak (see Notes 5 and 6)	50-MHz clock input (see Figure 8)		180		ps
<sup>t</sup> jit(pp)	Peak-to-peak jitter, (see Notes 5, 7, and 8)	100 Mbps 2 <sup>15</sup> –1 PRBS input (see Figure 8)		210		ps

† All typical values are at 25°C and with a 3.3-V supply voltage.

NOTES: 4.  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

- 5. Jitter parameters are based on design and characterization. Stimulus system jitter of 11 ps t<sub>jit(per)</sub>, 43 ps t<sub>jit(cc)</sub>, or 54 ps t<sub>jit(pp)</sub> have been subtracted from the values.
- 6. Input voltage = 0 V to  $V_{CC}$ ,  $t_f = t_f \le 1$  ns (20% to 80%), measured over 30k samples.
- 7. Input voltage = 0 V to V<sub>CC</sub>,  $t_r = t_f \le 1$  ns (20% to 80%), measured over 100k samples.
- 8. Peak-to-peak jitter includes jitter due to pulse skew  $(t_{sk(p)})$ .





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# receiver switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	·	MIN	TYP <sup>†</sup>	MAX	UNIT	
tPLH	Propagation delay time, low-to-high-level output			3	5	6.7	ns	
tPHL	Propagation delay time, high-to-low-level output			3	4.6	6.7	ns	
t <sub>sk(p)</sub>	Pulse skew ( tpHL tpLH )	0 5-5 0 5 10		400		ps		
tsk(pp)	Part-to-part skew (see Note 9)	C <sub>L</sub> = 5 pF, See Figure 10				1.5	ns	
t <sub>r</sub>	Output signal rise time		0.8	1.4	2	ns		
t <sub>f</sub>	Output signal fall time			8.0	1.5	2	ns	
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output		3.4	5.8	9	ns		
tPHL	Propagation delay time, high-to-low-level output		3.4	5.4	9	ns		
tsk(p)	Pulse skew ( tpHL tpLH )	0 45 = F 0 = Figure 40		400		ps		
tsk(pp)	Part-to-part skew (see Note 9)	C <sub>L</sub> = 15 pF, See Figure 10			2.5	ns		
t <sub>r</sub>	Output signal rise time		1	2	2.6	ns		
t <sub>f</sub>	Output signal fall time		1	1.4	2.6	ns		
tPHZ	Propagation delay time, high-level-to-high-impedance output			4.5	6	15	ns	
tPLZ	Propagation delay time, low-level-to-high-impedance output		2	3.4	5	ns		
<sup>t</sup> PZH	Propagation delay time, high-impedance-to-high-level output	See Figure 11		3.5	9.8	15	ns	
tPZL	Propagation delay time, high-impedance-to-low-level output			4	8.7	15	ns	
	Period jitter, rms (1 standard deviation)	50-MHz clock input	Type 1		10			
<sup>t</sup> jit(per)	(see Notes 10 and 11)	(see Figure 12)	Type 2		10		ps	
	O de terre de "90	50-MHz clock input	Type 1		93			
<sup>t</sup> jit(cc)	Cycle-to-cycle jitter, peak (see Notes 10 and 11)	(see Figure 12) Type 2			86		ps	
		100 Mbps 2 <sup>15</sup> –1 PRBS	Type 1	850				
<sup>t</sup> jit(pp)	Peak-to-peak jitter, (see Notes 10, 12, and 13)	input (see Figure 12)	Type 2		790		ps	

<sup>†</sup> All typical values are at 25°C and with a 3.3-V supply voltage.

- NOTES: 9.  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.
  - 10. Jitter parameters are based on design and characterization. Stimulus system jitter of 11 ps t<sub>jit(per)</sub>, 43 ps t<sub>jit(cc)</sub>, or 54 ps t<sub>jit(pp)</sub> have been subtracted from the values.
  - 11. Differential input voltage = 250 mV<sub>p-p</sub> (Type 1) or 500 mV<sub>p-p</sub> (Type 2),  $V_{CM} = 1 \text{ V}$ ,  $t_r = t_f \le 1 \text{ ns}$  (20% to 80%), measured over 30k samples.
  - 12. Differential input voltage = 250 mV<sub>p-p</sub> (Type 1) or 500 mV<sub>p-p</sub> (Type 2),  $V_{CM} = 1 \text{ V}$ ,  $t_r = t_f \le 1 \text{ ns}$  (20% to 80%), measured over 100k samples.
  - 13. Peak-to-peak jitter includes jitter due to pulse skew (t<sub>sk(p)</sub>).



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#### PARAMETER MEASUREMENT INFORMATION

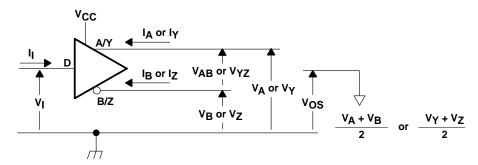
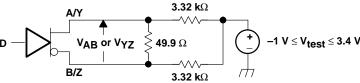
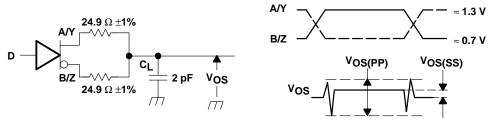


Figure 1. Driver Voltage and Current Definitions



NOTE: All resistors are 1% tolerance.

Figure 2. Differential Output Voltage Test Circuit



NOTE: All input pulses are supplied by a generator having the following characteristics: t<sub>r</sub> or t<sub>f</sub> ≤1 ns, pulse repetition rate (PRR) = 0.25 Mpps, pulse width = 500 ±10 ns. C<sub>L</sub> includes instrumentation and fixture capacitance within 0,06 m of the D.U.T. The measurement of V<sub>OS(PP)</sub> is made on test equipment with a −3-dB bandwidth of at least 1 GHz.

Figure 3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

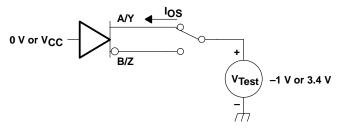


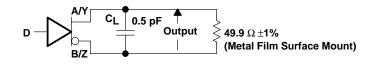
Figure 4. Driver Short-Circuit Test Circuit

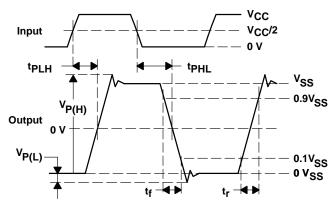


SN65MLVD200, SN65MLVD202 SN65MLVD204, SN65MLVD205 MULTIPOINT-LVDS LINE DRIVERS AND RECEIVERS

SLLS463E - SEPTEMBER 2001 - REVISED JUNE 2003

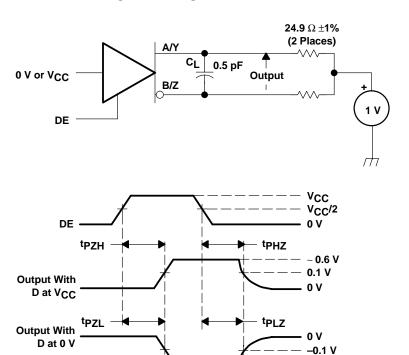
#### PARAMETER MEASUREMENT INFORMATION





NOTE: All input pulses are supplied by a generator having the following characteristics:  $t_{\Gamma}$  or  $t_{\Gamma} \le 1$  ns, pulse repetition rate (PRR) = 1 Mpps, pulse width =  $0.5 \pm 0.05 \,\mu s$ .  $C_{\Gamma}$  includes instrumentation and fixture capacitance within  $0.06 \, m$  of the D.U.T.

Figure 5. Driver Test Circuit, Timing, and Voltage Definitions for the Differential Output Signal



NOTE: All input pulses are supplied by a generator having the following characteristics:  $t_f$  or  $t_f \le 1$  ns, pulse repetition rate (PRR) = 0.25 Mpps, pulse width = 500  $\pm 10$  ns.  $C_L$  includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

~ -0.6 V

Figure 6. Driver Enable and DIsable Time Circuit and Definitions



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SLLS463E – SEPTEMBER 2001 – REVISED JUNE 2003

#### PARAMETER MEASUREMENT INFORMATION

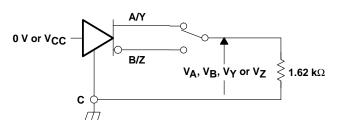
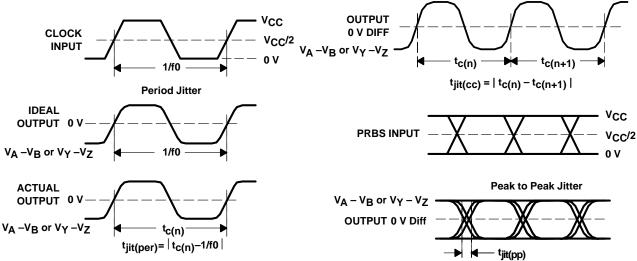


Figure 7. Maximum Steady-State Output Voltage Test Circuit



NOTES: A. All input pulses are supplied by an Agilent 8304A Stimulus System.

- B. The measurement is made on a TEK TDS6604 running TDSJIT3 application software
- C. Period jitter is measured using a 100 MHz 50  $\pm$ 1% duty cycle clock input.
- D. Peak-to-peak jitter is measured using a 200Mbps 2<sup>15</sup>–1 PRBS input.

Figure 8. Driver Jitter Measurement Waveforms

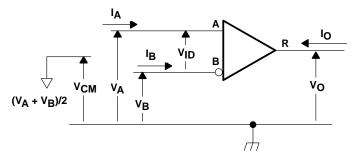


Figure 9. Receiver Voltage and Current Definitions



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#### PARAMETER MEASUREMENT INFORMATION

Table 1. Type-1 Receiver Input Threshold Test Voltages

APPLIED VOLTAGES		RESULTING DIFFERENTIAL INPUT VOLTAGE	RESULTING COMMON- MODE INPUT VOLTAGE	RECEIVER OUTPUT		
V <sub>A</sub> V <sub>B</sub>		V <sub>ID</sub>	V <sub>СМ</sub>	v <sub>o</sub>		
3.425 V	3.375 V	50 mV	3.4 V	Н		
3.375 V	3.425 V	–50 mV	3.4 V	L		
-0.975 V	-1.025 V	50 mV	-1.0 V	Н		
-1.025 V	-0.975 V	–50 mV	-1.0 V	L		
3.800 V	3.000 V	800 mV	3.4 V	Н		
3.000 V	3.800 V	−800 mV	3.4 V	L		
-0.600 V	–1.400 V	800 mV	–1.0 V	Н		
-1.400 V	-0.600 V	−800 mV	-1.0 V	L		

NOTE: H= high level, L = low level. Output state assumes receiver is enabled ( $\overline{RE}$  is Low).

Table 2. Type-2 Receiver Input Threshold Test Voltages

APPLIED VOLTAGES		RESULTING DIFFERENTIAL INPUT VOLTAGE	RESULTING COMMON- MODE INPUT VOLTAGE	RECEIVER OUTPUT		
VA	٧ <sub>B</sub>	V <sub>ID</sub>	V <sub>СМ</sub>	٧o		
3.475 V	3.325 V	150 mV	3.4 V	Н		
3.425 V	3.375 V	50 mV	3.4 V	L		
-0.925 V	–1.075 V	150 mV	–1.0 V	Н		
–0.975 V	-1.025 V	50 mV	–1.0 V	L		
3.800 V	3.000 V	800 mV	3.4 V	Н		
3.000 V	3.800 V	−800 mV	3.4 V	L		
-0.600 V	–1.400 V	800 mV	–1.0 V	Н		
-1.400 V	-0.600 V	−800 mV	-1.0 V	L		

NOTE: H= high level, L = low level. Output state assumes receiver is enabled ( $\overline{RE}$  is Low).



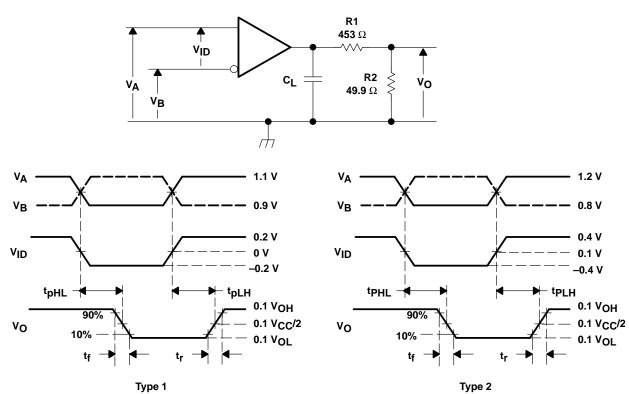
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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. All input pulses are supplied by a generator having the following characteristics:  $t_{\Gamma}$  or  $t_{\Gamma} \le 1$  ns, pulse repetition rate (PRR) = 1 Mpps, pulse width =  $0.5 \pm 0.05 \,\mu s$ .

- B. Resistors are 1% tolerance, metal film, and surface mount.
- C.  $\,$  CL is 20% tolerance, low-loss ceramic, and surface mount.
- D. R1 and  $C_L$  are located within 2 cm of the D.U.T.
- E. R2 is located within 15 cm of the D.U.T.

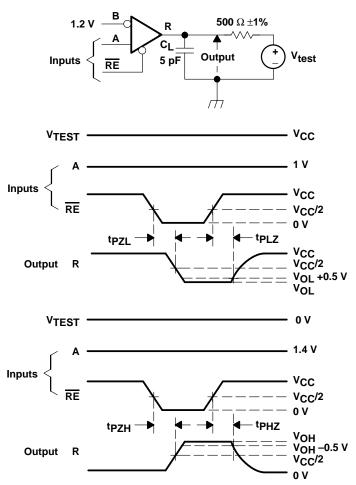
Figure 10. Receiver Timing Test Circuit and Waveforms



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#### PARAMETER MEASUREMENT INFORMATION



NOTE: All input pulses are supplied by a generator having the following characteristics: t<sub>r</sub> or t<sub>f</sub> ≤1 ns, pulse repetition rate (PRR) = 0.25 Mpps, pulse width = 500 ±10 ns. C<sub>L</sub> includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 11. Receiver Enable/Disable Time Test Circuit and Waveforms



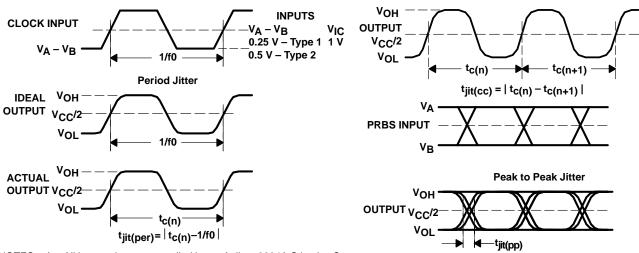
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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. All input pulses are supplied by an Agilent 8304A Stimulus System.

- B. The measurement is made on a TEK TDS6604 running TDSJIT3 application software
- C. Period jitter is measured using a 100 MHz 50 ±1% duty cycle clock input.
- D. Peak-to-peak jitter is measured using a 200Mbps 2<sup>15</sup>–1 PRBS input.

Figure 12. Receiver Jitter Measurement Waveforms



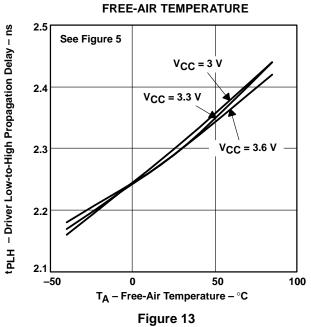
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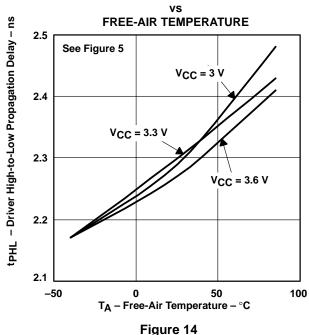
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#### TYPICAL CHARACTERISTICS

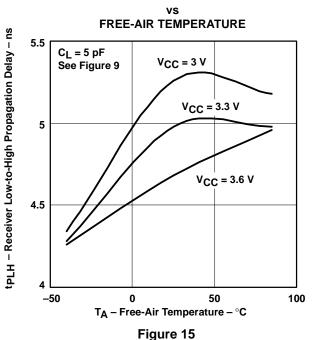
# DRIVER LOW-TO-HIGH PROPAGATION DELAY vs



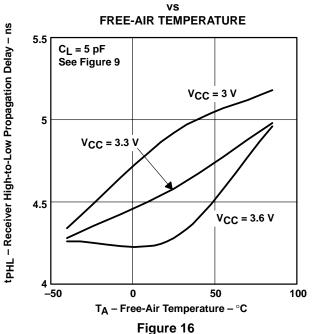
#### **DRIVER HIGH-TO-LOW PROPAGATION DELAY**



RECEIVER LOW-TO-HIGH PROPAGATION DELAY



RECEIVER HIGH-TO-LOW PROPAGATION DELAY





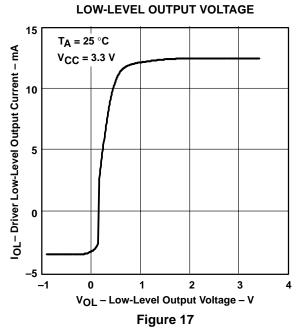


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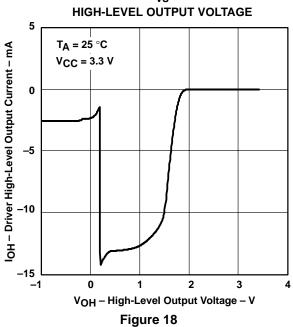
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#### TYPICAL CHARACTERISTICS

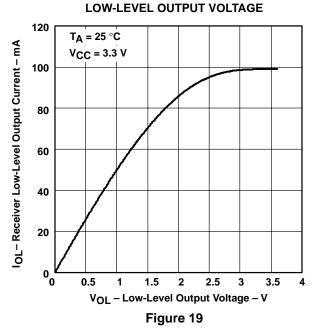
# DRIVER LOW-LEVEL OUTPUT CURRENT



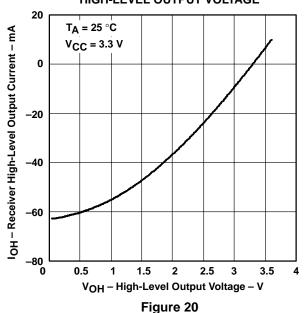
# **DRIVER HIGH-LEVEL OUTPUT CURRENT**



# **RECEIVER LOW-LEVEL OUTPUT CURRENT**



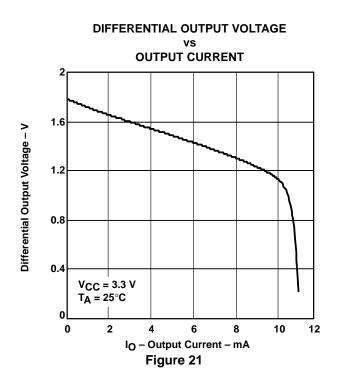
#### RECEIVER HIGH-LEVEL OUTPUT CURRENT vs HIGH-LEVEL OUTPUT VOLTAGE

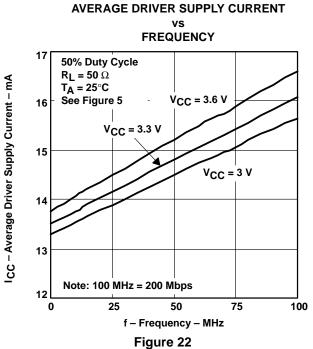


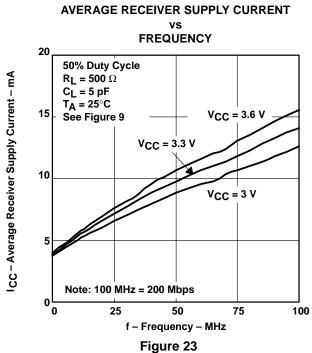


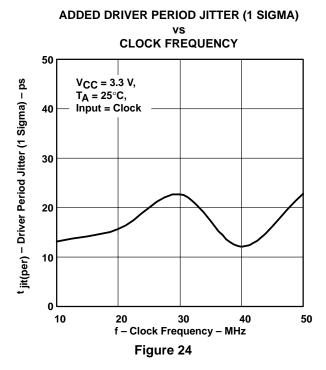
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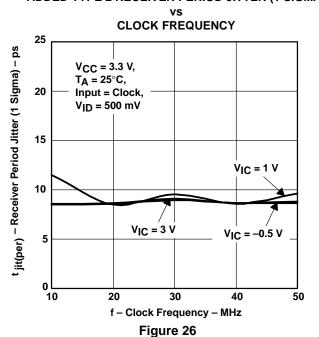
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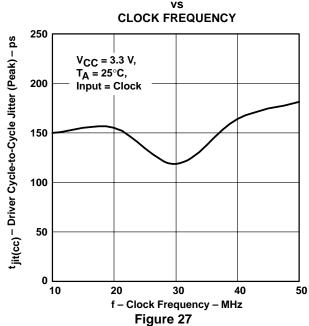
#### ADDED TYPE 1 RECEIVER PERIOD JITTER (1 SIGMA)

## **CLOCK FREQUENCY** 25 t jit(per) - Receiver Period Jitter (1 Sigma) - ps $V_{CC} = 3.3 V,$ $T_A = 25^{\circ}C$ , 20 Input = Clock, V<sub>ID</sub> = 250 mV $V_{IC} = -0.5 V$ V<sub>IC</sub> = 3 V 15 10 V<sub>IC</sub> = 1 V 5 10 30 50 f - Clock Frequency - MHz Figure 25

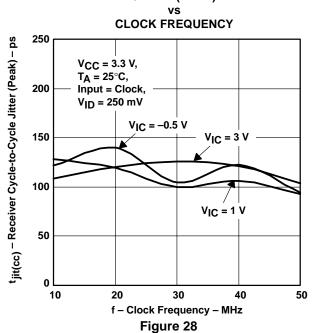
#### ADDED TYPE 2 RECEIVER PERIOD JITTER (1 SIGMA)



ADDED DRIVER CYCLE-TO-CYCLE JITTER (PEAK)



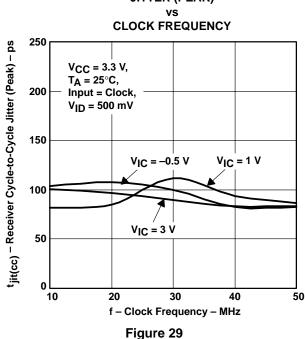
ADDED TYPE 1 RECEIVER CYCLE-TO-CYCLE JITTER (PEAK)



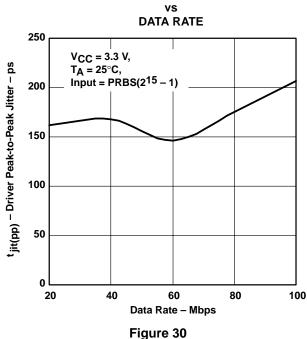


#### TYPICAL CHARACTERISTICS

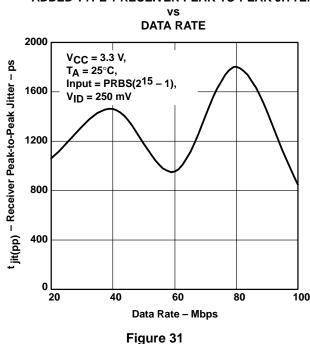
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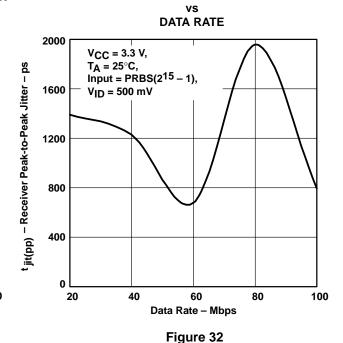
# ADDED DRIVER PEAK-TO-PEAK JITTER



#### ADDED TYPE 1 RECEIVER PEAK-TO-PEAK JITTER



#### ADDED TYPE 2 RECEIVER PEAK-TO-PEAK JITTER







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SLLS463E - SEPTEMBER 2001 - REVISED JUNE 2003

#### **APPLICATION INFORMATION**

#### Type-1 and Type-2 receivers

The M-LVDS standard defines Type-1 and Type-2 receivers. Type-1 receivers include no provisions for failsafe and have their differential input voltage thresholds near zero volts. Type-2 receivers have their differential input voltage thresholds offset from zero volts to detect the absence of a voltage difference. Type-1 receivers maximize the differential noise margin and are intended for maximum signaling rates. Type-2 receivers are intended for control signals and slower signaling rates. The impact on receiver output by the offset input can be seen in Table 3 and Figure 33.

Table 3. M-LVDS Receiver Input Voltage Threshold Requirements

Receiver Type	Output Low	Output High			
1	$-2.4 \text{ V} \le \text{V}_{1D} \le -0.05 \text{ V}$	$0.05 \text{ V} \le \text{V}_{1D} \le 2.4 \text{ V}$			
2	$-2.4 \text{ V} \le \text{V}_{1D} \le 0.05 \text{ V}$	0.15 V ≤ V <sub>ID</sub> ≤ 2.4 V			

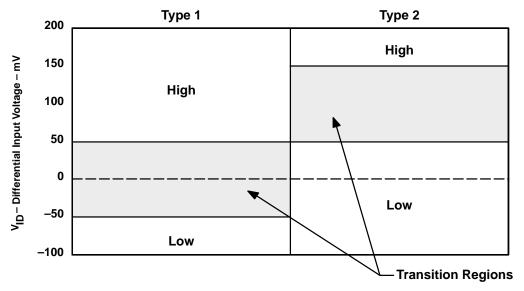


Figure 33. Receiver Differential Input Voltage Showing Transition Region



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#### **APPLICATION INFORMATION**

#### comparison of M-LVDS with RS-485

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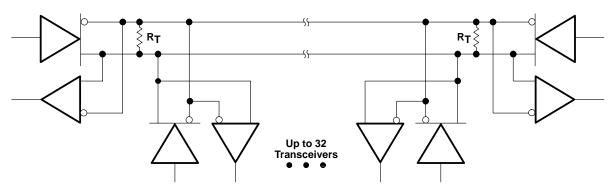
RS-485 applications are similar to M-LVDS. The two standards define balanced multipoint systems with some basic architecture changes due to the different applications. Table 4 gives a high-level comparison of the two different technologies.

Table 4. Comparison Between M-LVDS and RS-485 Standards

	Number of Loads	Differential Voltage Range	Common-Mode Voltage Range	Maximum Signaling Rate (Mbps)	Receiver Minimum Threshold		
RS-485	32	1.5 V to 5 V	–7 V to 12 V	50 Mbps	±200 mV		
M-LVDS	32	480 mV to 650 mV	–1 V to 3.4 V	500 Mbps	±50 mV		

It can be seen that with the greater differential output voltage and common-mode voltage range of the RS-485-type device, it can handle longer signaling distances where M-LVDS offers ten times the signaling rate of RS-485.

SN65MLVD200 SN65MLVD200



NOTE A: The line should be terminated at both ends in its characteristic impedance (R<sub>T</sub> = Z<sub>O</sub>). Stub lengths off the main line should be kept as short as possible.

Figure 34. Typical Application Circuit





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PACKAGE OPTION ADDENDUM

24-Apr-2015

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN65MLVD200D	NRND	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MF200	
SN65MLVD200DG4	NRND	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MF200	
SN65MLVD200DR	NRND	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MF200	
SN65MLVD200DRG4	NRND	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MF200	
SN65MLVD202D	NRND	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MLVD202	
SN65MLVD202DG4	NRND	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MLVD202	
SN65MLVD202DR	NRND	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MLVD202	
SN65MLVD204D	NRND	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MF204	
SN65MLVD204DR	NRND	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MF204	
SN65MLVD205D	NRND	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	MLVD205	

(1) The marketing status values are defined as follows:

\* The flatfetting status values are defined as follows.
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): This terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flieber between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS Compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight



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PACKAGE OPTION ADDENDUM

www.ti.com 24-Apr-2015

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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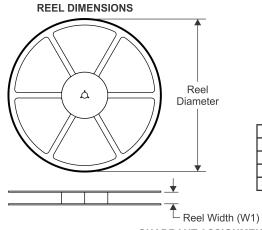
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## PACKAGE MATERIALS INFORMATION

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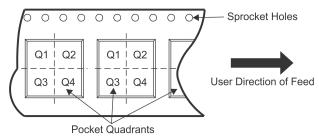
#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS KO P1 BO W Cavity AO

A0	
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

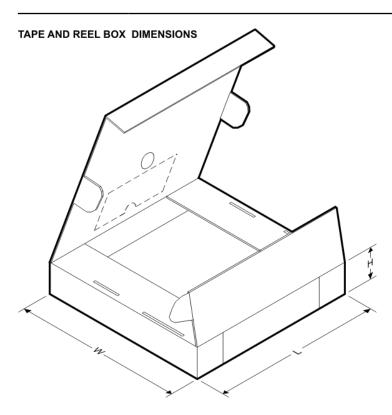
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65MLVD200DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN65MLVD202DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN65MLVD204DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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# **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

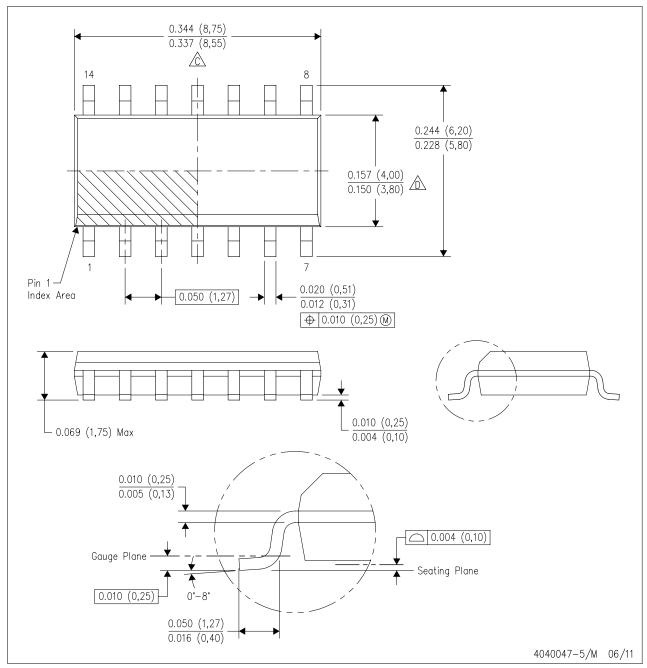
7 til diffictions die fromina											
	Device	Device Package Type Package		Pins	SPQ	Length (mm)	Width (mm)	Height (mm)			
	SN65MLVD200DR	SOIC	D	8	2500	340.5	338.1	20.6			
	SN65MLVD202DR	SOIC	D	14	2500	333.2	345.9	28.6			
	SN65MLVD204DR	SOIC	D	8	2500	340.5	338.1	20.6			



#### **MECHANICAL DATA**

# D (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

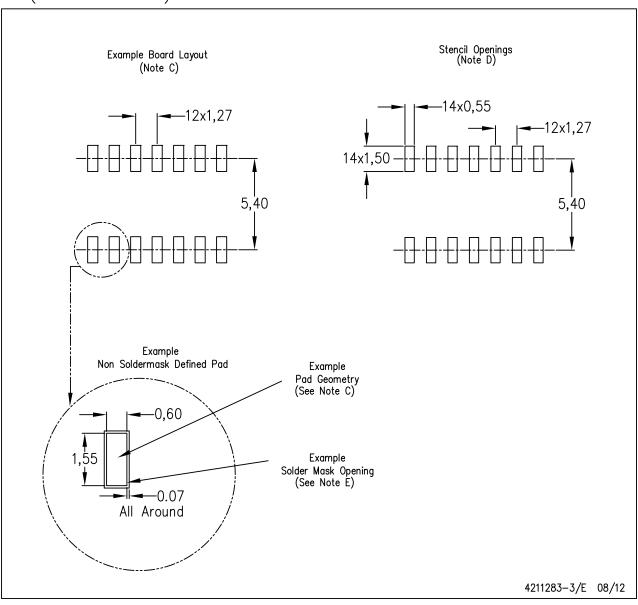




#### **LAND PATTERN DATA**

# D (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

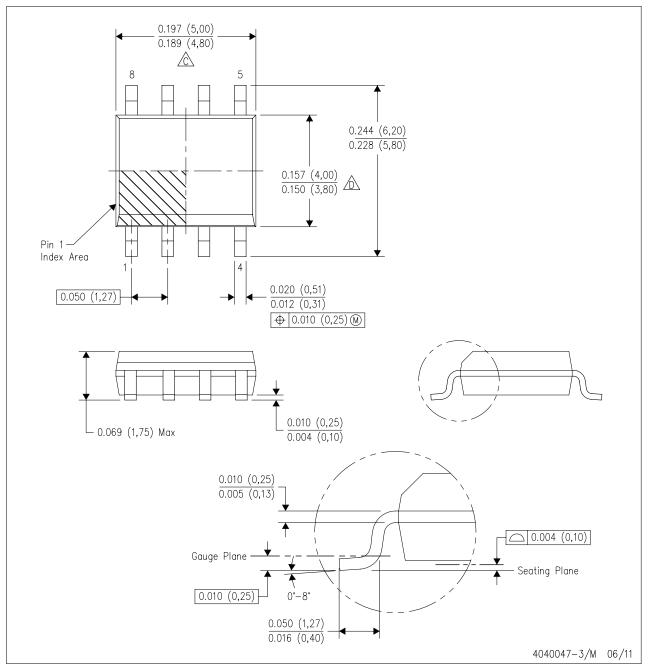




#### **MECHANICAL DATA**

# D (R-PDSO-G8)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.

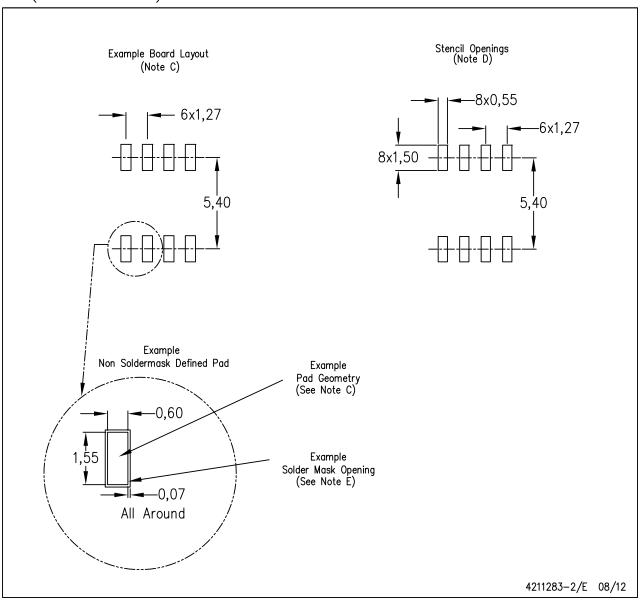




#### LAND PATTERN DATA

# D (R-PDSO-G8)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





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